Component Title:

RESISTOR, FIXED, CHIP, METAL FOIL BASED ON TYPE SMP-PW, SMS-PW, SMT-PW according to ESCC Det. Spec. 4001/027 respectively BASED ON TYPE SMR-PW, SMV-PW according to ESCC Det. Spec.4001/028

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German Space Agency at DLR

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Components (include	ling series and families) s	submitted for Extension of	Qualification	Approval:			•	1
ESCC COMPONENT NO.	VARIANTS	RANGE OF COMPONENTS			ASED ON	TEST VEHICLE / S	COMPONENT SIMILAR	Г
4001/027	01 05 02 02 02		SMP-PW (2010)) SMS-PW (2512) SMS-PW (2512) SMS-PW (2512) SMT-PW (2817)			Variant 03 SMT-PW (2817) Variant 04 SMP-PW (2010)		
001/028 02 02 02				SMV-PW (4723) SMV-PW (4723) SMV-PW (4723)		SMV-R018-1.0-PW SMV-R039-0.5-PW SMV-R270-1.0-PW	Variant 01 SMR-PW	(4723)
Component M	Manufacturer 2	Location of Manu	facturing Plant	(s)	3			4
Isabellenhütte Heu	sler GmbH & Co. KG	Eibacher Weg 3-5 34683 Dillenburg Germany			Date of original qualification approval: Date: 24/11/2008 Certificate Ref No. 285			
ESCC Specification Maintenance of qua		Deviations to LVT testinused:	ng and Detail S	Specification	6 on	Qualification Extension R	Report reference and dat	te:
Generic: 4001	Issue: 5	No ⊠ Y ☐ (supply details in Box 15)			Requalification Test Report 2024 Certificate 285 G, D-QM-20, 24.06.2024			
Detail(s): 4001/0		Deviation from current No ⊠ Yes [	Specifications:					
Summary of procure	ement or equivalent test r				nis applic	ation (those to ESCC listed		8
Project Name	Testing Level	LAT		ate code		Quant	ity Delivered	
See Appendix: Confidential: Orders 01/01/2022 - 24/06/2024								
PID changes since s	start of qualification	9 0	Current PID V	erified by	Rur	ak Gökgöz, German Spac	re Agency at DLR	10
None	start or qualification	<u> </u>	ourient ID V	cilica by.		Name of Excutive Re		_ 10
Minor* ⊠		F	Ref No:	QS 010	/ DQS	011		
Major* □	*Provide details in box:	1	ssue: I	ss. 8	1 1	ss. 10	Date: 17/07/202	4
	See Apper	ndix 2, Box 19	Rev Date:	4/02/2024	/ 26/07	7/2023		
Current Manufacturi	ng facilities surveyed by:	Burak Gökgöz, Ge	erman Space	Agency at	DLR	on 11	/06/2024	11
		(Name of Execu	tive Represen	tative)			(Date)	
Satisfactory:	Yes ⊠	No □ Expl	ain					
Report Reference:	ISA-AUD-DL Issue 1 (Date							

Component title:

RESISTOR, FIXED, CHIP, METAL FOIL BASED ON TYPE SMP-PW, SMS-PW, SMT-PW according to ESCC Det. Spec. 4001/027 respectively BASED ON TYPE SMR-PW, SMV-PW according to

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Failure Analysis, DPA, NCCS available:	Yes	No	⊠	(Supply data)	12_
Ref. No's and purposes:					
					40

The undersigned hereby certifies on behalf of the ESCC Executive, that the above information is correct; that the appropriate documentation has been evaluated; that full compliance to all ESCC requirements is evidence except as stated in box 15; that the reports and data are available at the ESCC **Executive** and therefore applies for ESCC qualification status to be extended to the component(s) listed herein.

Digital signiert von Burak Goekgoez
DN: C=DE, S=Nordrhein-Westfalen, L=
Koeln, O=Deutshee Zentrum füer Luft-und
Raumfahrt et. (DLR), SN=Goekgoez, G=
Burak, CN=Burak Goekgoez
Grund: Ich bin der Verfasser dieses
Dokuments
Ort: Bonn
Datum: 2024.07.31 21:37:03+02'00'
Foxt PDF Editor Version: 13.1.2 Date: 31/07/2024 i.A. Burak Gökgöz (Signature of the ESCC Executive Coordinator) Continuation of Boxes above: 14

Component title:

RESISTOR, FIXED, CHIP, METAL FOIL BASED ON TYPE SMP-PW, SMS-PW, SMT-PW according to ESCC Det. Spec. 4001/027 respectively BASED ON TYPE SMR-PW, SMV-PW according to ESCC Det. Spec.4001/028

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Executive Member: German Space Agency at DLR 31/07/2024 Date: 285 H 15 Non compliance to ESCC requirements: Specification Paragraph Non compliance Additional tasks required to achieve full compliance for ESCC qualification or rationale for acceptability of 16 noncompliance: **Executive Manager Disposition** 17 Application Approval: Yes No Action / Remarks:

Date:

B. Schade: Head of the Product Assurance and Safety Department

RESISTOR, FIXED, CHIP, METAL FOIL BASED ON TYPE SMP-PW, SMS-PW, SMT-PW according to ESCC Det. Spec. 4001/027 respectively BASED ON TYPE SMR-PW, SMV-PW according to

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Executive Member: German Space Agency at DLR

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ANNEX 1: LIST OF TESTS DONE TO SUPPORT EXTENSION OF QUALIFICATION

Tests conducted in compliance with:

ESCC 4001 generic specification; Chart F4 (for ESCC/QPL parts); or PID-TFD (for ESCC/QML parts)

(for ESCC/QML parts)

Tests vehicle identification/description:

SMP-R470-1.0-PW SMS-R005-1.0-PW	S03 (17526) R45 (29645)	
SMS-R030-1.0-PW	R45 (29643)	
SMS-1R00-1.0-PW	R41 (29625)	
SMT-R005-1.0-PW	S02 (17518)	

Component Title:

Detail Specification reference: 4001/027 issue 8 Ex: three-digit code year letter R=2023 / S=2024 + week number

Chart F4	Test	Tick when done	Conditions	Date Code	Teste d Qty	N° of Rejects	Comments if not performed. Comments on Rejection
	Mounting		IEC 60115-1 clause 4.31	S03, R45, R45, R41, S02	5 x 15	0	
	Rapid Change Of Temperature		IEC 60068-2-14	S03, R45, R45, R41, S02	5 x 15	0	
	Vibration	⊠	IEC 60068-2-6	S03, R45, R45, R41, S02	5 x 15	0	
	Climatic test Sequence	⊠	ESCC 4001, Para 8.10	S03, R45, R45, R41, S02	5 x 15	0	
유	Seal Test		IEC 60068-2-17				
ubgro	Mounting		IEC 60115-1 clause 4.31				
ical Si	Robustness of Terminations		IEC 60068-2-21				
chan	Climatic test Sequence		ESCC 4001, Para 8.10				
al /Me	Seal Test		IEC 60068-2-17				
Environmental Mechanical Subgroup	Resistance to Soldering Heat	⊠	IEC 60068-2-20	S03, R45, R45, R41, S02	5×6	0	
	Mounting	⊠	IEC 60115-1 clause 4.31	S03, R45, R45, R41, S02	5 x 6	0	
	Climatic test Sequence	⊠	ESCC 4001, Para 8.10	S03, R45, R45, R41, S02	5 x 6	0	
	Seal Test		IEC 60068-2-17				
	Mounting		IEC 60115-1 clause 4.31				
	Insulation Resistance		ESCC 4001, Para 8.3.1.2				
	Voltage Proof		ESCC 4001, Para 8.3.1.3				
Endurance Subgroup	Mounting	⊠	IEC 60115-1 clause 4.31	S03, R45, R45, R41, S02	5 x 15	0	3700
	Operating Life	⊠	ESCC 4001, Para 8.13	S03, R45, R45, R41, S02	5 x 15	0	
	Seal Test		IEC 60068-2-17				
Assembly Capability Subgroup	Solderability	⊠	IEC 60068-2-20	S03, R45, R45, R41, S02	5 x 6	0	
	Permanence of marking		ESCC 24800				
ition II sts	Operating Life (8000h)		ESCC 4001, Para 8.13				
Addition al Tests	Seal Test		IEC 60068-2-17				

Component Title:

RESISTOR, FIXED, CHIP, METAL FOIL BASED ON TYPE SMP-PW, SMS-PW, SMT-PW according to ESCC Det. Spec. 4001/027 respectively BASED ON TYPE SMR-PW, SMV-PW according to

Date:

31/07/2024

ESCC Det. Spec.4001/028 Executive Member: German Space Agency at DLR Appl. No.

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ANNEX 1: LIST OF TESTS DONE TO SUPPORT EXTENSION OF QUALIFICATION

Tests conducted in compliance with:

ESCC 4001 generic specification; Chart F4 (for ESCC/QPL parts); or PID-TFD (for ESCC/QML parts)

Tests vehicle identification/description:

R45 (17204) SMV-R018-1.0-PW SMV-R039-0.5-PW SMV-R270-1.0-PW R45 (17206) R45 (17205) Click here to enter text.

4001/028 issue 6 Ex: three-digit code year letter R=2023 + week number Detail Specification reference:

Chart F4	Test	Tick when done	Conditions	Date Code	Tested Qty	N° of Rejects	Comments if not performed. Comments on Rejection
d	Mounting	⊠	IEC 60115-1 clause 4.31	R45	3 x 15	0	
	Rapid Change Of Temperature	⊠	IEC 60068-2-14	R45	3 x 15	0	
	Vibration	⊠	IEC 60068-2-6	R45	3 x 15	0	
	Climatic test Sequence	⊠	ESCC 4001, Para 8.10	R45	3 x 15	0	
	Seal Test		IEC 60068-2-17				
bgrou	Mounting		IEC 60115-1 clause 4.31				
sal Su	Robustness of Terminations		IEC 60068-2-21				
chanic	Climatic test Sequence		ESCC 4001, Para 8.10				
I /Me	Seal Test	0	IEC 60068-2-17				
Environmental /Mechanical Subgroup	Resistance to Soldering Heat	⊠	IEC 60068-2-20	R45	3 x 6	0	
viron	Mounting	⊠	IEC 60115-1 clause 4.31	R45	3×6	0	
Ē	Climatic test Sequence	⊠	ESCC 4001, Para 8.10	R45	3 x 6	0	
	Seal Test		IEC 60068-2-17				
	Mounting	⊠	IEC 60115-1 clause 4.31	R45	3 x 15	0	
	Insulation Resistance	⋈	ESCC 4001, Para 8.3.1.2	R45	3 x 15	0	
	Voltage Proof	⊠	ESCC 4001, Para 8.3.1.3	R45	3 x 15	0	
Endurance Subgroup	Mounting	⊠	IEC 60115-1 clause 4.31	R45	3 x 15	0	
	Operating Life	⊠	ESCC 4001, Para 8.13	R45	3 x 15	0	
	Seal Test		IEC 60068-2-17				
Assembly Capability Subgroup	Solderability	⊠	IEC 60068-2-20	R45	3 x 6	0	
	Permanence of marking		ESCC 24800				
tion	Operating Life		ESCC 4001, Para 8.13				
Addition all Tests	Seal Test		IEC 60068-2-17				



Component title:

RESISTOR, FIXED, CHIP, METAL FOIL BASED ON TYPE SMP-PW, SMS-PW, SMT-PW according to ESCC Det. Spec. 4001/027 respectively BASED ON TYPE SMR-PW, SMV-PW according to ESCC Det. Spec.4001/028

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NOTES ON THE COMPLETION OF THE APPLICATION FORM FOR ESCC QUALIFICATION EXTENSION APPROVAL

ENTRIES	
Form heading	shall indicate: - the title of the component as given in its detail specification or the name of the series, family; - the Executive Member; - the entering date; - the certificate number and its sequential suffix.
Box 1	shall provide details given in the table; in particular there shall be listed: - the variants or range of variants; - the range of components (the ESCC code is recommended to indicate the values or values range, the tolerance, the voltage, etc); the designation given in the detail specification as 'base on'; - under Test Vehicle enter either an ESCC code or the specific characteristic capable of identifying the component tested (e.g., voltage of coil for a relay); - under component similar enter a cross if relevant.
Box 2; 3 and 4	As per QPL entry; otherwise, an explanation of the changes must be supplied.
Box 5	Will show the ESCC Generic and Detail specifications, including issue number and revision letter, current at the time the tests reported were performed. If the specifications are different from those current on the date of the application, see Box 6.
Box 6	Will show the deviations from the Generic and Detail Specifications listed in Box 5, in particular deviations from testing. In case of deviations this must be listed in Box 15. In case the referenced specification in Box 5 have currently a different issue and/or revision indicate also whether the test data deviates or not from such current documents.
Box 7	Must reference the report(s) supplied in support of the application.
Box 8	Should provide the details of procurement to the full ESCC System, documentation of all of which should already have been delivered to the ESCC Executive under the terms of the relevant Generic Specification. An appropriate table has been drawn in this box.
Box 9	If the PID evolved after the Original Qualification or after the last Extension of Qualification, adequate details of such evolution shall be provided together with the reasons for the changes. Major changes shall be clearly marked.
Box 10	Identify the current PID issue status, date and actual date of verification. The date of verification of the current PID should be arranged as close as possible to the required date of extension.
Box 11	This box can be completed only after a physical visit to the plant to confirm that no unexplained changes occurred and that the practices, procedures, material, etc. used in manufacturing the components are as described in the PID. This survey shall be carried out in accordance with the requirements of ESCC Basic Specification No. 20200 and its findings shall be recorded.
Box 12	Provide details of, or reference to, any Destructive Physical Analysis (DPA) and Failure Analysis reports as well as any Nonconformance(s) (NCCS) occurred during the qualification validity period, stating if established corrective action have produced satisfactory results.
Box 13	Enter only the name of the Executive Member (i.e., CNES, DLR, ESTEC, etc.) and the signature of the responsible Executive Coordinator.
Box 14	To be used when there is a need to expand any of the boxes from 1 through 12. Identify box affected and reference the Box 14 in the relevant Box. Box 14 can be broken into 14a, 14b, etc. if several boxes have to be expanded.
Box 15	Fill in Table as requested.
Box 16	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
Box 17	All Executive Manager recommendations on the application itself, special conditions or restrictions, modifications of the QPL or QML entry, letters to the manufacturer, etc. shall be entered clearly in Box 19, signed by the representative for ESA, and dated.
Box 18	Fill in Table as requested.
Box 19	Confidential Details of PID changes including those of a confidential nature, shall be provided.
Box 20	State noncompliance with reference to specification(s) and paragraph(s). To simplify reference in Box 16 each nonconformance shall be sequentially numbered. If relevant state 'None'.
Box 21	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
Box 22	Additional Comments.